

## PATENT COOPERATION TREATY

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## INTERNATIONAL PRELIMINARY EXAMINATION REPORT

(PCT Article 36 and Rule 70)

Applicant's or agent's file reference 102412-101	<b>FOR FURTHER ACTION</b> See Notification of Transmittal of International Preliminary Examination Report (Form PCT/IPEA/416)	
International application No. PCT/US03/29569	International filing date (day/month/year) 23 September 2003 (23.09.2003)	Priority date (day/month/year) 30 September 2002 (30.09.2002)
International Patent Classification (IPC) or national classification and IPC IPC(7): G02B 5/32; G03H 1/04; B05D 3/00; C08J 7/18; G21H 5/00 and US Cl.: 359/15;430/1,2;427/553		
Applicant ADVANCED INTERCONNECT TECHNOLOGIES LIMITED		

1. This international preliminary examination report has been prepared by this International Preliminary Examining Authority and is transmitted to the applicant according to Article 36.

2. This REPORT consists of a total of 4 sheets, including this cover sheet.

☐ This report is also accompanied by ANNEXES, i.e., sheets of the description, claims and/or drawings which have been amended and are the basis for this report and/or sheets containing rectifications made before this Authority (see Rule 70.16 and Section 607 of the Administrative Instructions under the PCT).

These annexes consist of a total of \_\_\_\_ sheets.

3. This report contains indications relating to the following items:

- I ☒ Basis of the report
- II ☐ Priority
- III ☐ Non-establishment of report with regard to novelty, inventive step and industrial applicability
- IV ☐ Lack of unity of invention
- V ☒ Reasoned statement under Article 35(2) with regard to novelty, inventive step or industrial applicability; citations and explanations supporting such statement
- VI ☐ Certain documents cited
- VII ☐ Certain defects in the international application
- VIII ☐ Certain observations on the international application

Date of submission of the demand 02 March 2004 (02.03.2004)	Date of completion of this report 04 January 2005 (04.01.2005)
Name and mailing address of the IPEA/US Mail Stop PCT, Attn: IPEA/US Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450 Facsimile No. (703)305-3230	Authorized officer David Nhu Telephone No. (571)0272-1792 <b>DEBORAH A. THOMAS</b> <b>PARALEGAL SPECIALIST</b> <del>GROUP 1300</del> <i>Dut</i>

**I. Basis of the report**

1. With regard to the elements of the international application:\*
- ☒ the international application as originally filed.
  - ☒ the description:
    - pages 1-14 as originally filed
    - pages NONE, filed with the demand
    - pages NONE, filed with the letter of \_\_\_\_\_.
  - ☒ the claims:
    - pages 15-19, as originally filed
    - pages NONE, as amended (together with any statement) under Article 19
    - pages NONE, filed with the demand
    - pages NONE, filed with the letter of \_\_\_\_\_.
  - ☒ the drawings:
    - pages 1-11, as originally filed
    - pages NONE, filed with the demand
    - pages NONE, filed with the letter of \_\_\_\_\_.
  - ☐ the sequence listing part of the description:
    - pages NONE, as originally filed
    - pages NONE, filed with the demand
    - pages NONE, filed with the letter of \_\_\_\_\_.
2. With regard to the language, all the elements marked above were available or furnished to this Authority in the language in which the international application was filed, unless otherwise indicated under this item. These elements were available or furnished to this Authority in the following language \_\_\_\_\_ which is:
- ☐ the language of a translation furnished for the purposes of international search (under Rule 23.1(b)).
  - ☐ the language of publication of the international application (under Rule 48.3(b)).
  - ☐ the language of the translation furnished for the purposes of international preliminary examination (under Rules 55.2 and/or 55.3).
3. With regard to any nucleotide and/or amino acid sequence disclosed in the international application, the international preliminary examination was carried out on the basis of the sequence listing:
- ☐ contained in the international application in printed form.
  - ☐ filed together with the international application in computer readable form.
  - ☐ furnished subsequently to this Authority in written form.
  - ☐ furnished subsequently to this Authority in computer readable form.
  - ☐ The statement that the subsequently furnished written sequence listing does not go beyond the disclosure in the international application as filed has been furnished.
  - ☐ The statement that the information recorded in computer readable form is identical to the written sequence listing has been furnished.
4. ☐ The amendments have resulted in the cancellation of:
- ☐ the description, pages NONE
  - ☐ the claims, Nos. NONE
  - ☐ the drawings, sheets/fig NONE
5. ☐ This report has been established as if (some of) the amendments had not been made, since they have been considered to go beyond the disclosure as filed, as indicated in the Supplemental Box (Rule 70.2(c)).\*\*

\* Replacement sheets which have been furnished to the receiving Office in response to an invitation under Article 14 are referred to in this report as "originally filed" and are not annexed to this report since they do not contain amendments (Rules 70.16 and 70.17).

\*\* Any replacement sheet containing such amendments must be referred to under item 1 and annexed to this report.

**V. Reasoned statement under Rule 66.2(a)(ii) with regard to novelty, inventive step or industrial applicability; citations and explanations supporting such statement****1. STATEMENT**

Novelty (N)	Claims <u>1-25</u>	YES
	Claims <u>NONE</u>	NO
Inventive Step (IS)	Claims <u>1-25</u>	YES
	Claims <u>NONE</u>	NO
Industrial Applicability (IA)	Claims <u>1-25</u>	YES
	Claims <u>NONE</u>	NO

**2. CITATIONS AND EXPLANATIONS**

CLAIMS 1-25 MEET THE CRITERIA SET OUT IN PCT ARTICLE 33(2)-(4), BECAUSE THE PRIOR ART DO NOT TEACH OR FAIRLY SUGGEST A METHOD FOR MANUFACTURING PACKAGED SEMICONDUCTOR DEVICES COMPRISING: DISPOSING A PLURALITY OF DIES ONTO A PLURALITY OF INTERCONNECTED SUBSTRATE; ELECTRICALLY CONNECTING I/O PADS ON EACH DIE IN THE PLURALITY OF DIES TO BOND SITES ON AN ASSOCIATED SUBSTRATE IN THE PLURALITY OF INTERCONNECTED SUBSTRATE; SECURING A PLURALITY OF INTERCONNECTED HEAT SPREADER OVER THE PLURALITY OF DIES; OVERMOLDING THE PLURALITY OF DIES, THE BOND SITES, AND THE PLURALITY OF INTERCONNECTED HEAT SPREADER WITH A CONTINUOUS COATING OF MOLDING COMPOUND TO FORM A PLURALITY OF INTERCONNECTED PACKAGE PRECURSORS; AND SINGULATING THE INTERCONNECTED PACKAGE PRECURSORS TO PROVIDE A PLURALITY OF PACKAGE.

----- NEW CITATIONS -----  
NONE

## INTERNATIONAL PRELIMINARY EXAMINATION REPORT

International Application No.  
PCT/US03/

## Supplemental Box

(To be used when the space in any of the preceding boxes is not sufficient)

## Continuation of Certain Documents Cited

## 1. Certain published documents (Rule 70.10)

Application No <u>Patent No.</u>	Publication Date <u>(day/month/year)</u>	Filing Date <u>(day/month/year)</u>	Priority date (valid claim) <u>(day/month/year)</u>
5,905,632	05/18/1999 (18.05.1999)	11/06/1997 (06.11.1997)	None
5,650,663	07/22/1997 (22.07.1997)	07/03/1995 (03.07.1995)	None
5,367,196	11/22/1994 (22.11.1994)	09/17/1992 (17.09.1992)	None

## 2. Non-written disclosures (Rule 70.9)

<u>Kind of non-written disclosure</u>	Date of non-written disclosure <u>(day/month/year)</u>	Date of written disclosure referring to non-written disclosure <u>(day/month/year)</u>
None	None	None